



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



FEATURES
Pin-compatible family
Excellent dynamic performance
AD9736: SFDR = 82 dBc at $f_{OUT} = 30$ MHz
AD9736: SFDR = 69 dBc at $f_{OUT} = 130$ MHz
AD9736: IMD = 87 dBc at $f_{OUT} = 30$ MHz
AD9736: IMD = 82 dBc at $f_{OUT} = 130$ MHz
LVDS data interface with on-chip 100 Ω terminations
Built-in self test
LVDS sampling integrity
LVDS-to-DAC data transfer integrity
Low power: 380 mW ($I_{FS} = 20$ mA; $f_{OUT} = 330$ MHz)
1.8/3.3 V dual-supply operation
Adjustable analog output
8.66 mA to 31.66 mA ($R_L = 25 \Omega$ to 50 Ω)
On-chip 1.2 V reference
160-lead chip scale ball grid array (CSP_BGA) package
APPLICATIONS
Broadband communications systems
Cellular infrastructure (digital predistortion)
Point-to-point wireless
CMTS/VOD
Instrumentation, automatic test equipment
Radar, avionics
GENERAL DESCRIPTION

The AD9736, AD9735, and AD9734 are high performance, high frequency DACs that provide sample rates of up to 1200 MSPS, permitting multicarrier generation up to their Nyquist frequency. The AD9736 is the 14-bit member of the family, while the AD9735 and the AD9734 are the 12-bit and 10-bit members, respectively. They include a serial peripheral interface (SPI) port that provides for programming of many internal parameters and enables readback of status registers.

A reduced-specification LVDS interface is utilized to achieve the high sample rate. The output current can be programmed over a range of 8.66 mA to 31.66 mA. The AD973x family is manufactured on a 0.18 μm CMOS process and operates from 1.8 V and 3.3 V supplies for a total power consumption of 380 mW in bypass mode. It is supplied in a 160-lead chip scale ball grid array for reduced package parasitics.

Rev. A

Information furnished by Analog Devices is believed to be accurate and reliable. However, no responsibility is assumed by Analog Devices for its use, nor for any infringements of patents or other rights of third parties that may result from its use. Specifications subject to change without notice. No license is granted by implication or otherwise under any patent or patent rights of Analog Devices. Trademarks and registered trademarks are the property of their respective owners.

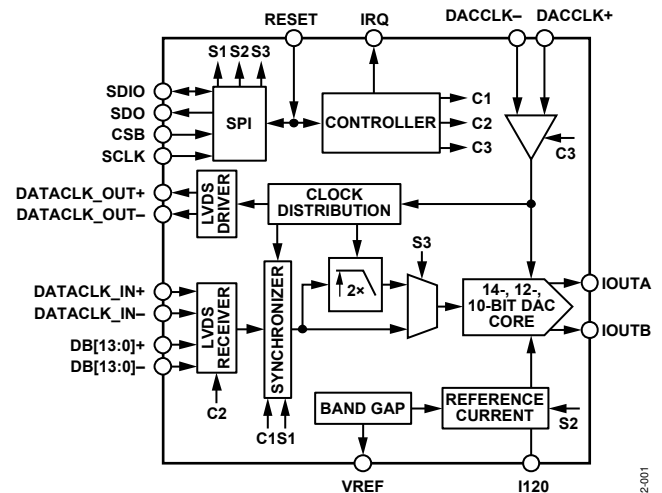
FUNCTIONAL BLOCK DIAGRAM


Figure 1.

PRODUCT HIGHLIGHTS

1. Low noise and intermodulation distortion (IMD) features enable high quality synthesis of wideband signals at intermediate frequencies up to 600 MHz.
2. Double data rate (DDR) LVDS data receivers support the maximum conversion rate of 1200 MSPS.
3. Direct pin programmability of basic functions or SPI port access offers complete control of all AD973x family functions.
4. Manufactured on a CMOS process, the AD973x family uses a proprietary switching technique that enhances dynamic performance.
5. The current output(s) of the AD9736 family are easily configured for single-ended or differential circuit topologies.

TABLE OF CONTENTS

Features	1	Full Scale Current (FSC) Registers (Reg. 2, Reg. 3)	31
Applications.....	1	LVDS Controller (LVDS_CNT) Registers (Reg. 4, Reg. 5, Reg. 6)	31
General Description	1	SYNC Controller (SYNC_CNT) Registers (Reg. 7, Reg. 8).....	32
Functional Block Diagram	1	Cross Controller (CROS_CNT) Registers (Reg. 10, Reg. 11).....	32
Product Highlights	1	Analog Control (ANA_CNT) Registers (Reg. 14, Reg. 15).....	33
Revision History	3	Built-In Self Test Control (BIST_CNT) Registers (Reg. 17, Reg. 18, Reg. 19, Reg. 20, Reg. 21)	33
Specifications.....	4	Controller Clock Predivider (CCLK_DIV) Reading Register (Reg. 22)	34
DC Specifications	4	Theory of Operation	35
Digital Specifications	6	Serial Peripheral Interface	36
AC Specifications.....	8	General Operation of the Serial Interface.....	36
Absolute Maximum Ratings.....	9	Short Instruction Mode (8-Bit Instruction)	36
Thermal Resistance	9	Long Instruction Mode (16-Bit Instruction).....	36
ESD Caution.....	9	Serial Interface Port Pin Descriptions	36
Pin Configurations and Function Descriptions	10	SCLK—Serial Clock.....	36
Location of Supply and Control Pins.....	16	CSB—Chip Select.....	37
Terminology	17	SDIO—Serial Data I/O.....	37
Typical Performance Characteristics	18	SDO—Serial Data Out	37
AD9736 Static Linearity, 10 mA Full Scale	18	MSB/LSB Transfers	37
AD9736 Static Linearity, 20 mA Full Scale	19	Notes on Serial Port Operation	37
AD9736 Static Linearity, 30 mA Full Scale	20	Pin Mode Operation	38
AD9735 Static Linearity, 10 mA, 20 mA, 30 mA Full Scale.....	21	RESET Operation	38
AD9734 Static Linearity, 10 mA, 20 mA, 30 mA Full Scale.....	22	Programming Sequence	38
AD9736 Power Consumption, 20 mA Full Scale.....	23	Interpolation Filter	39
AD9736 Dynamic Performance, 20 mA Full Scale.....	24	Data Interface Controllers.....	39
AD9735, AD9734 Dynamic Performance, 20 mA Full Scale.....	27	LVDS Sample Logic.....	40
AD973x WCDMA ACLR, 20 mA Full Scale	28	LVDS Sample Logic Calibration.....	40
SPI Register Map.....	29	Operating the LVDS Controller in Manual Mode via the SPI Port	41
SPI Register Details	30		
Mode Register (Reg. 0)	30		
Interrupt Request Register (IRQ) (Reg. 1)	30		

<p>Operating the LVDS Controller in Surveillance and Auto Mode41</p> <p>SYNC Logic and Controller.....42</p> <p> SYNC Logic and Controller Operation.....42</p> <p> Operation in Manual Mode.....42</p> <p> Operation in Surveillance and Auto Modes.....42</p> <p> FIFO Bypass.....42</p> <p>Digital Built-In Self Test (BIST)44</p> <p> Overview44</p> <p> AD973x BIST Procedure.....45</p> <p> AD973x Expected BIST Signatures45</p> <p> Generating Expected Signatures46</p> <p>Cross Controller Registers47</p> <p>Analog Control Registers48</p> <p> Band Gap Temperature Characteristic Trim Bits48</p>	<p>Mirror Roll-Off Frequency Control48</p> <p>Headroom Bits.....48</p> <p>Voltage Reference.....48</p> <p>Applications Information.....50</p> <p> Driving the DACCLK Input50</p> <p>DAC Output Distortion Sources.....51</p> <p>DC-Coupled DAC Output.....52</p> <p>DAC Data Sources53</p> <p>Input Data Timing54</p> <p>Synchronization Timing.....55</p> <p>Power Supply Sequencing.....56</p> <p>AD973x Evaluation Board Schematics57</p> <p>AD973x Evaluation Board PCB Layout.....62</p> <p>Outline Dimensions.....69</p> <p> Ordering Guide69</p>
---	---

REVISION HISTORY

9/06—Rev. 0 to Rev. A

Updated Format.....	Universal
Changes to Table 1	5
Changes to Table 2	6
Changes to Table 3	8
Inserted Table 5.....	9
Replaced Pin Configuration and Function Descriptions Section	10
Changes to Figure 27 to Figure 38	21
Changes to Figure 40	23
Changes to Table 9	29
Changes to Figure 103	56
Changes to Figure 105	58
Changes to Figure 107	60
Changes to Figure 108	61
Changes to Figure 115	68
Updated Outline Dimensions.....	69
Changes to Ordering Guide.....	69

4/05—Revision 0: Initial Version

AD9734/AD9735/AD9736

SPECIFICATIONS

DC SPECIFICATIONS

AVDD33 = DVDD33 = 3.3 V, CVDD18 = DVDD18 = 1.8 V, maximum sample rate, $I_{FS} = 20$ mA, 1× mode, 25 Ω , 1% balanced load, unless otherwise noted.

Table 1.

Parameter	AD9736			AD9735			AD9734			Unit
	Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
RESOLUTION	14			12			10			Bits
ACCURACY										
Integral Nonlinearity (INL)	-5.6	±1.0	+5.6	-1.5	±0.50	+1.5	-0.5	±0.12	+0.5	LSB
Differential Nonlinearity (DNL)	-2.1	±0.6	+2.1	-0.5	±0.25	+0.5	-0.1	±0.06	+0.1	LSB
ANALOG OUTPUTS										
Offset Error	-0.01	±0.005	+0.01	-0.01	±0.005	+0.01	-0.01	±0.005	+0.01	% FSR
Gain Error (With Internal Reference)	±1.0			±1.0			±1.0			% FSR
Gain Error (Without Internal Reference)	±1.0			±1.0			±1.0			% FSR
Full-Scale Output Current	8.66	20.2	31.66	8.66	20.2	31.66	8.66	20.2	31.66	mA
Output Compliance Range	-1.0		+1.0	-1.0		1.0	-1.0		+1.0	V
Output Resistance	10			10			10			M Ω
Output Capacitance	1			1			1			pF
TEMPERATURE DRIFT										
Offset	0			0			0			ppm/°C
Gain	80			80			80			ppm/°C
Reference Voltage ¹	40			40			40			ppm/°C
REFERENCE										
Internal Reference Voltage ¹	1.14	1.2	1.26	1.14	1.2	1.26	1.14	1.2	1.26	V
Output Resistance ²	5			5			5			k Ω
ANALOG SUPPLY VOLTAGES										
AVDD33	3.13	3.3	3.47	3.13	3.3	3.47	3.13	3.3	3.47	V
CVDD18	1.70	1.8	1.90	1.70	1.8	1.90	1.70	1.8	1.90	V
DIGITAL SUPPLY VOLTAGES										
DVDD33	3.13	3.3	3.47	3.13	3.3	3.47	3.13	3.3	3.47	V
DVDD18	1.70	1.8	1.90	1.70	1.8	1.90	1.70	1.8	1.90	V
SUPPLY CURRENTS										
1× Mode, 1.2 GSPS										
I _{AVDD33}	25			25			25			mA
I _{CVDD18}	47			47			47			mA
I _{DVDD33}	10			10			10			mA
I _{DVDD18}	122			122			122			mA
FIR Bypass (1×) Mode	380			380			380			mW
2× Mode, 1.2 GSPS										
I _{AVDD33}	25			25			25			mA
I _{CVDD18}	47			47			47			mA
I _{DVDD33}	10			10			10			mA
I _{DVDD18}	234			234			234			mA
FIR 2× Interpolation Filter Enabled	550			550			550			mW

AD9734/AD9735/AD9736

Parameter	AD9736			AD9735			AD9734			Unit
	Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
Static, No Clock										
I _{AVDD33}		25			25			25		mA
I _{CVDD18}		8			8			8		mA
I _{DVDD33}		10			10			10		mA
I _{DVDD18}		2			2			2		mA
FIR Bypass (1×) Mode		133			133			133		mW
Sleep Mode, No Clock										
I _{AVDD33}		2.5	3.15		2.5	3.15		2.5	3.15	mA
FIR Bypass (1×) Mode		59	65		59	65		59	65	mW
Power-Down Mode ³										
I _{AVDD33}		0.01	0.13		0.01	0.13		0.01	0.13	mA
I _{CVDD18}		0.02	0.12		0.02	0.12		0.02	0.12	mA
I _{DVDD33}		0.01	0.12		0.01	0.12		0.01	0.12	mA
I _{DVDD18}		0.01	0.11		0.01	0.11		0.01	0.11	mA
FIR Bypass (1×) Mode		0.12	1.24		0.12	1.24		0.12	1.24	mW

¹ Default band gap adjustment (Reg. 0x0E <2:0> = 0x0).

² Use an external amplifier to drive any external load.

³ Typical wake-up time is 8 μs with recommended 1 nF capacitor on VREF pin.

AD9734/AD9735/AD9736

DIGITAL SPECIFICATIONS

AVDD33 = DVDD33 = 3.3 V, CVDD18 = DVDD18 = 1.8 V, maximum sample rate, $I_{FS} = 20$ mA, 1× mode, 25 Ω , 1% balanced load, unless otherwise noted. LVDS drivers and receivers are compliant to the IEEE-1596 reduced range link, unless otherwise noted.

Table 2.

Parameter	Min	Typ	Max	Unit
LVDS DATA INPUT (DB[13:0]+, DB[13:0]–) DB+ = V_{IA} , DB– = V_{IB}				
Input Voltage Range, V_{IA} or V_{IB}	825		1575	mV
Input Differential Threshold, V_{IDTH}	–100		+100	mV
Input Differential Hysteresis, $V_{IDTHH} - V_{IDTHL}$		20		mV
Receiver Differential Input Impedance, R_{IN}	80		120	Ω
LVDS Input Rate	1200			MSPS
LVDS Minimum Data Valid Period (t_{MDE})			344	ps
LVDS CLOCK INPUT (DATACLK_IN+, DATACLK_IN–) DATACLK_IN+ = V_{IA} , DATACLK_IN– = V_{IB}				
Input Voltage Range, V_{IA} or V_{IB}	825		1575	mV
Input Differential Threshold, ¹ V_{IDTH}	–100		+100	mV
Input Differential Hysteresis, $V_{IDTHH} - V_{IDTHL}$		20		mV
Receiver Differential Input Impedance, R_{IN}	80		120	Ω
Maximum Clock Rate	600			MHz
LVDS CLOCK OUTPUT (DATACLK_OUT+, DATACLK_OUT–) DATACLK_OUT+ = V_{OA} , DATACLK_OUT– = V_{OB} 100 Ω Termination				
Output Voltage High, V_{OA} or V_{OB}			1375	mV
Output Voltage Low, V_{OA} or V_{OB}	1025			mV
Output Differential Voltage, $ V_{OD} $	150	200	250	mV
Output Offset Voltage, V_{OS}	1150		1250	mV
Output Impedance, Single-Ended, R_o	80	100	120	Ω
R_o Mismatch Between A and B, ΔR_o			10	%
Change in $ V_{OD} $ Between 0 and 1, $ \Delta V_{OD} $			25	mV
Change in V_{OS} Between 0 and 1, ΔV_{OS}			25	mV
Output Current—Driver Shorted to Ground, I_{SA} , I_{SB}			20	mA
Output Current—Drivers Shorted Together, I_{SAB}			4	mA
Power-Off Output Leakage, $ I_{XA} $, $ I_{XB} $			10	mA
Maximum Clock Rate	600			MHz
DAC CLOCK INPUT (CLK+, CLK–)				
Input Voltage Range, CLK– or CLK+	0		800	
Differential Peak-to-Peak Voltage	400	800	1600	mV
Common-Mode Voltage	300	400	500	mV
Maximum Clock Rate	1200			MHz
SERIAL PERIPHERAL INTERFACE				
Maximum Clock Rate (f_{SCLK} , $1/t_{SCLK}$)			20	MHz
Minimum Pulse Width High, t_{PWH}	20			ns
Minimum Pulse Width Low, t_{PWL}	20			ns
Minimum SDIO and CSB to SCLK Setup, t_{DS}		10		ns
Minimum SCLK to SDIO Hold, t_{DH}		5		ns
Maximum SCLK to Valid SDIO and SDO, t_{DV}		20		ns
Minimum SCLK to Invalid SDIO and SDO, t_{DNV}		5		ns

AD9734/AD9735/AD9736

Parameter	Min	Typ	Max	Unit
INPUT (SDI, SDIO, SCLK, CSB)				
Voltage in High, V_{IH}	2.0	3.3		V
Voltage in Low, V_{IL}		0	0.8	V
Current in High, I_{IH}	-10		+10	μ A
Current in Low, I_{IL}	-10		+10	μ A
SDIO OUTPUT				
Voltage out High, V_{OH}	2.4		3.6	V
Voltage out Low, V_{OL}	0		0.4	V
Current out High, I_{OH}		4		mA
Current out Low, I_{OL}		4		mA

¹Refer to the Input Data Timing section for recommended LVDS differential drive levels.

AD9734/AD9735/AD9736

AC SPECIFICATIONS

AVDD33 = DVDD33 = 3.3 V, CVDD18 = DVDD18 = 1.8 V, maximum sample rate, $I_{FS} = 20$ mA, 1× mode, 25 Ω, 1% balanced load, unless otherwise noted.

Table 3.

Parameter	AD9736			AD9735			AD9734			Unit
	Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
DYNAMIC PERFORMANCE										
Maximum Update Rate	1200			1200			1200			MSPS
SPURIOUS-FREE DYNAMIC RANGE (SFDR)										
$f_{DAC} = 800$ MSPS										
$f_{OUT} = 20$ MHz	75			75			75			dBc
$f_{DAC} = 1200$ MSPS										
$f_{OUT} = 50$ MHz	80			76			76			dBc
$f_{OUT} = 100$ MHz	77			74			71			dBc
$f_{OUT} = 316$ MHz	63			63			60			dBc
$f_{OUT} = 550$ MHz	55			54			53			dBc
TWO-TONE INTERMODULATION DISTORTION (IMD)										
$f_{DAC} = 1200$ MSPS										
$f_{OUT2} = f_{OUT} + 1.25$ MHz										
$f_{OUT} = 40$ MHz	88			84			83			dBc
$f_{OUT} = 50$ MHz	85			84			83			dBc
$f_{OUT} = 100$ MHz	84			81			79			dBc
$f_{OUT} = 316$ MHz	70.5			67			66			dBc
$f_{OUT} = 550$ MHz	65			60			60			dBc
NOISE SPECTRAL DENSITY (NSD)										
Single Tone										
$f_{DAC} = 1200$ MSPS										
$f_{OUT} = 50$ MHz	-165			-162			-154			dBm/Hz
$f_{OUT} = 100$ MHz	-164			-161			-154			dBm/Hz
$f_{OUT} = 241$ MHz	-158.5	-160.5		-159.5			-155			dBm/Hz
$f_{OUT} = 316$ MHz	-158			-157			-152			dBm/Hz
$f_{OUT} = 550$ MHz	-155			-155			-149			dBm/Hz
Eight-Tone										
$f_{DAC} = 1200$ MSPS, 500 kHz Tone Spacing										
$f_{OUT} = 50$ MHz	-166.5			-163			-154			dBm/Hz
$f_{OUT} = 100$ MHz	-166			-163			-152			dBm/Hz
$f_{OUT} = 241$ MHz	-163.3	-165		-161.5			-150.5			dBm/Hz
$f_{OUT} = 316$ MHz	-164			-162			-151			dBm/Hz
$f_{OUT} = 550$ MHz	-162			-160			-150			dBm/Hz

ABSOLUTE MAXIMUM RATINGS

Table 4.

Parameter	With Respect to	Min	Max
AVDD33	AVSS	-0.3 V	+3.6 V
DVDD33	DVSS	-0.3 V	+3.6 V
DVDD18	DVSS	-0.3 V	+1.98 V
CVDD18	CVSS	-0.3 V	+1.98 V
AVSS	DVSS	-0.3 V	+0.3 V
AVSS	CVSS	-0.3 V	+0.3 V
DVSS	CVSS	-0.3 V	+0.3 V
CLK+, CLK-	CVSS	-0.3 V	CVDD18 + 0.18 V
PIN_MODE	DVSS	-0.3 V	DVDD33 + 0.3 V
DATACLK_IN, DATACLK_OUT	DVSS	-0.3 V	DVDD33 + 0.3 V
LVDS Data Inputs	DVSS	-0.3 V	DVDD33 + 0.3 V
IOUTA, IOUTB	AVSS	-1.0 V	AVDD33 + 0.3 V
I120, VREF, IPTAT	AVSS	-0.3 V	AVDD33 + 0.3 V
IRQ, CSB, SCLK, SDO, SDIO, RESET	DVSS	-0.3 V	DVDD33 + 0.3 V
Junction Temperature			150°C
Storage Temperature		-65°C	+150°C

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum ratings for extended periods may effect device reliability.

THERMAL RESISTANCE

θ_{JA} is specified for the worst-case conditions, that is, a device soldered in a circuit board for surface-mount packages.

Table 5. Thermal Resistance

Package Type	θ_{JA} ¹	Unit
160-Lead Ball, CSP_BGA	31.2	°C/W

¹ θ_{JA} measurement in still air.

ESD CAUTION

ESD (electrostatic discharge) sensitive device. Electrostatic charges as high as 4000 V readily accumulate on the human body and test equipment and can discharge without detection. Although this product features proprietary ESD protection circuitry, permanent damage may occur on devices subjected to high energy electrostatic discharges. Therefore, proper ESD precautions are recommended to avoid performance degradation or loss of functionality.



Note that this device in its current form does not meet Analog Devices' standard requirements for ESD as measured against the charged device model (CDM). As such, special care should be used when handling this product, especially in a manufacturing environment. Analog Devices will provide a more ESD-hardy product in the near future at which time this warning will be removed from this data sheet.

PIN CONFIGURATIONS AND FUNCTION DESCRIPTIONS

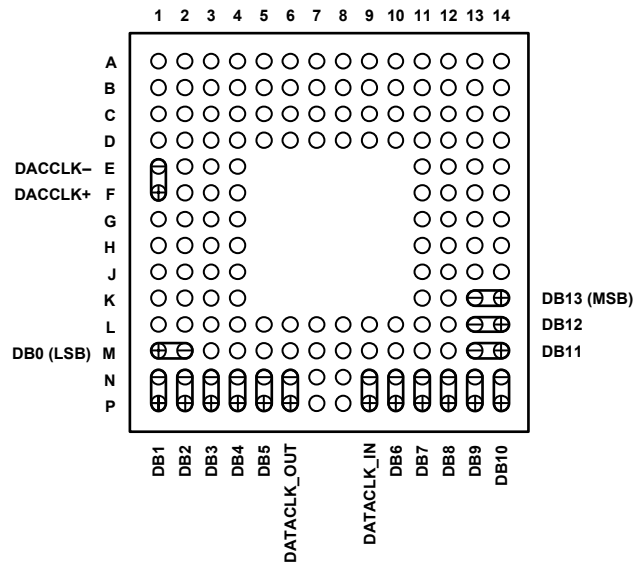


Figure 2. AD9736 Digital LVDS Input, Clock I/O (Top View)

Table 6. AD9736 Pin Function Descriptions

Pin No.	Mnemonic	Description
A1, A2, A3, B1, B2, B3, C1, C2, C3, D2, D3	CVDD18	1.8 V Clock Supply.
A4, A5, A6, A9, A10, A11, B4, B5, B6, B9, B10, B11, C4, C5, C6, C9, C10, C11, D4, D5, D6, D9, D10, D11	AVSS	Analog Supply Ground.
A7, B7, C7, D7	IOUTB	DAC Negative Output. 10 mA to 30 mA full-scale output current.
A8, B8, C8, D8	IOUTA	DAC Positive Output. 10 mA to 30 mA full-scale output current.
A12, A13, B12, B13, C12, C13, D12, D13	AVDD33	3.3 V Analog Supply.
A14	DNC	Do Not Connect.
B14	I120	Nominal 1.2 V Reference. Tie to analog ground via 10 kΩ resistor to generate a 120 μA reference current.
C14	VREF	Band Gap Voltage Reference I/O. Tie to analog ground via 1 nF capacitor; output impedance is approximately 5 kΩ.
D1, E2, E3, E4, F2, F3, F4, G1, G2, G3, G4	CVSS	Clock Supply Ground.
D14	IPTAT	Factory Test Pin. Output current, proportional to absolute temperature, is approximately 10 μA at 25°C with a slope of approximately 20 nA/°C.
E1, F1	DACCLK-/DACCLK+	Negative/Positive DAC Clock Input (DACCLK).
E11, E12, F11, F12, G11, G12	AVSS	Analog Supply Ground Shield. Tie to AVSS at the DAC.
E13	IRQ/UNSIGNED	If PIN_MODE = 0, IRQ: Active low open-drain interrupt request output, pull up to DVDD33 with 10 kΩ resistor. If PIN_MODE = 1, UNSIGNED: Digital input pin where 0 = twos complement input data format, 1 = unsigned.
E14	RESET/PD	If PIN_MODE = 0, RESET: 1 resets the AD9736. If PIN_MODE = 1, PD: 1 puts the AD9736 in the power-down state.
F13	CSB/2×	See the Serial Peripheral Interface section and the Pin Mode Operation section for pin description.
F14	SDIO/FIFO	See the Pin Mode Operation section for pin description.
G13	SCLK/FSC0	See the Pin Mode Operation section for pin description.
G14	SDO/FSC1	See the Pin Mode Operation section for pin description.
H1, H2, H3, H4, H11, H12, H13, H14, J1, J2, J3, J4, J11, J12, J13, J14	DVDD18	1.8 V Digital Supply.

Pin No.	Mnemonic	Description
K1, K2, K3, K4, K11, K12, L2, L3, L4, L5, L6, L9, L10, L11, L12, M3, M4, M5, M6, M9, M10, M11, M12	DVSS	Digital Supply Ground.
K13, K14	DB<13>-/DB<13>+	Negative/Positive Data Input Bit 13 (MSB). Conforms to IEEE-1596 reduced range link.
L1	PIN_MODE	0 = SPI Mode. SPI is enabled. 1 = PIN Mode. SPI is disabled; direct pin control.
L7, L8, M7, M8, N7, N8, P7, P8	DVDD33	3.3 V Digital Supply.
L13, L14	DB<12>-/DB<12>+	Negative/Positive Data Input Bit 12. Conforms to IEEE-1596 reduced range link.
M2, M1	DB<0>-/DB<0>+	Negative/Positive Data Input Bit 0 (LSB). Conforms to IEEE-1596 reduced range link.
M13, M14	DB<11>-/DB<11>+	Negative/Positive Data Input Bit 11. Conforms to IEEE-1596 reduced range link.
N1, P1	DB<1>-/DB<1>+	Negative/Positive Data Input Bit 1. Conforms to IEEE-1596 reduced range link.
N2, P2	DB<2>-/DB<2>+	Negative/Positive Data Input Bit 2. Conforms to IEEE-1596 reduced range link.
N3, P3	DB<3>-/DB<3>+	Negative/Positive Data Input Bit 3. Conforms to IEEE-1596 reduced range link.
N4, P4	DB<4>-/DB<4>+	Negative/Positive Data Input Bit 4. Conforms to IEEE-1596 reduced range link.
N5, P5	DB<5>-/DB<5>+	Negative/Positive Data Input Bit 5. Conforms to IEEE-1596 reduced range link.
N6, P6	DATACLK_OUT-/ DATACLK_OUT+	Negative/Positive Data Output Clock. Conforms to IEEE-1596 reduced range link.
N9, P9	DATACLK_IN-/ DATACLK_IN+	Negative/Positive Data Input Clock. Conforms to IEEE-1596 reduced range link.
N10, P10	DB<6>-/DB<6>+	Negative/Positive Data Input Bit 6. Conforms to IEEE-1596 reduced range link.
N11, P11	DB<7>-/DB<7>+	Negative/Positive Data Input Bit 7. Conforms to IEEE-1596 reduced range link.
N12, P12	DB<8>-/DB<8>+	Negative/Positive Data Input Bit 8. Conforms to IEEE-1596 reduced range link.
N13, P13	DB<9>-/DB<9>+	Negative/Positive Data Input Bit 9. Conforms to IEEE-1596 reduced range link.
N14, P14	DB<10>-/DB<10>+	Negative/Positive Data Input Bit 10. Conforms to IEEE-1596 reduced range link.

AD9734/AD9735/AD9736

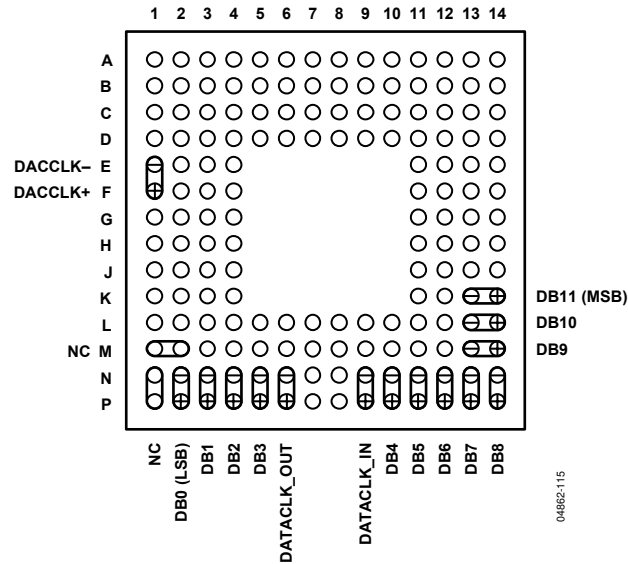


Figure 3. AD9735 Digital LVDS Input, Clock I/O (Top View)

Table 7. AD9735 Pin Function Descriptions

Pin No.	Mnemonic	Description
A1, A2, A3, B1, B2, B3, C1, C2, C3, D2, D3	CVDD18	1.8 V Clock Supply.
A4, A5, A6, A9, A10, A11, B4, B5, B6, B9, B10, B11, C4, C5, C6, C9, C10, C11, D4, D5, D6, D9, D10, D11	AVSS	Analog Supply Ground.
A7, B7, C7, D7	IOUTB	DAC Negative Output. 10 mA to 30 mA full-scale output current.
A8, B8, C8, D8	IOUTA	DAC Positive Output. 10 mA to 30 mA full-scale output current.
A12, A13, B12, B13, C12, C13, D12, D13	AVDD33	3.3 V Analog Supply.
A14	DNC	Do Not Connect.
B14	I120	Nominal 1.2 V Reference. Tie to analog ground via 10 kΩ resistor to generate a 120 μA reference current.
C14	VREF	Band Gap Voltage Reference I/O. Tie to analog ground via 1 nF capacitor; output impedance approximately 5 kΩ.
D1, E2, E3, E4, F2, F3, F4, G1, G2, G3, G4	CVSS	Clock Supply Ground.
D14	IPTAT	Factory Test Pin; Output current, proportional to absolute temperature, is approximately 10 μA at 25°C with a slope of approximately 20 nA/°C.
E1, F1	DACCLK-/DACCLK+	Negative/Positive DAC Clock Input (DACCLK).
E11, E12, F11, F12, G11, G12	AVSS	Analog Supply Ground Shield. Tie to AVSS at the DAC.
E13	IRQ/UNSIGNED	If PIN_MODE = 0, IRQ: Active low open-drain interrupt request output, pull up to DVDD33 with 10 kΩ resistor. If PIN_MODE = 1, UNSIGNED: Digital input pin where 0 = twos complement input data format, 1 = unsigned.
E14	RESET/PD	If PIN_MODE = 0, RESET: 1 resets the AD9735. If PIN_MODE = 1, PD: 1 puts the AD9735 in the power-down state.
F13	CSB/2×	See the Serial Peripheral Interface section and the Pin Mode Operation section for pin description.
F14	SDIO/FIFO	See the Pin Mode Operation section for pin description.
G13	SCLK/FSC0	See the Pin Mode Operation section for pin description.
G14	SDO/FSC1	See the Pin Mode Operation section for pin description.
H1, H2, H3, H4, H11, H12, H13, H14, J1, J2, J3, J4, J11, J12, J13, J14	DVDD18	1.8 V Digital Supply.
K1, K2, K3, K4, K11, K12, L2, L3, L4, L5, L6, L9, L10, L11, L12, M3, M4, M5, M6, M9, M10, M11, M12	DVSS	Digital Supply Ground.

Pin No.	Mnemonic	Description
K13, K14	DB<11>-/DB<11>+	Negative/Positive Data Input Bit 11 (MSB). Conforms to IEEE-1596 reduced range link.
L1	PIN_MODE	0 = SPI Mode. SPI is enabled. 1 = PIN Mode. SPI disabled; direct pin control.
L7, L8, M7, M8, N7, N8, P7, P8	DVDD33	3.3 V Digital Supply.
L13, L14	DB<10>-/DB<10>+	Negative/Positive Data Input Bit 10. Conforms to IEEE-1596 reduced range link.
M1, M2	NC	No Connect.
M13, M14	DB<9>-/DB<9>+	Negative/Positive Data Input Bit 9. Conforms to IEEE-1596 reduced range link.
N1, P1	NC	No Connect.
N2, P2	DB<0>-/DB<0>+	Negative/Positive Data Input Bit 0 (LSB). Conforms to IEEE-1596 reduced range link.
N3, P3	DB<1>-/DB<1>+	Negative/Positive Data Input Bit 1. Conforms to IEEE-1596 reduced range link.
N4, P4	DB<2>-/DB<2>+	Negative/Positive Data Input Bit 2. Conforms to IEEE-1596 reduced range link.
N5, P5	DB<3>-/DB<3>+	Negative/Positive Data Input Bit 3. Conforms to IEEE-1596 reduced range link.
N6, P6	DATACLK_OUT-/ DATACLK_OUT+	Negative/Positive Data Output Clock. Conforms to IEEE-1596 reduced range link.
N9, P9	DATACLK_IN-/ DATACLK_IN+	Negative/Positive Data Input Clock. Conforms to IEEE-1596 reduced range link.
N10, P10	DB<4>-/DB<4>+	Negative/Positive Data Input Bit 4. Conforms to IEEE-1596 reduced range link.
N11, P11	DB<5>-/DB<5>+	Negative/Positive Data Input Bit 5. Conforms to IEEE-1596 reduced range link.
N12, P12	DB<6>-/DB<6>+	Negative/Positive Data Input Bit 6. Conforms to IEEE-1596 reduced range link.
N13, P13	DB<7>-/DB<7>+	Negative/Positive Data Input Bit 7. Conforms to IEEE-1596 reduced range link.
N14, P14	DB<8>-/DB<8>+	Negative/Positive Data Input Bit 8. Conforms to IEEE-1596 reduced range link.

AD9734/AD9735/AD9736

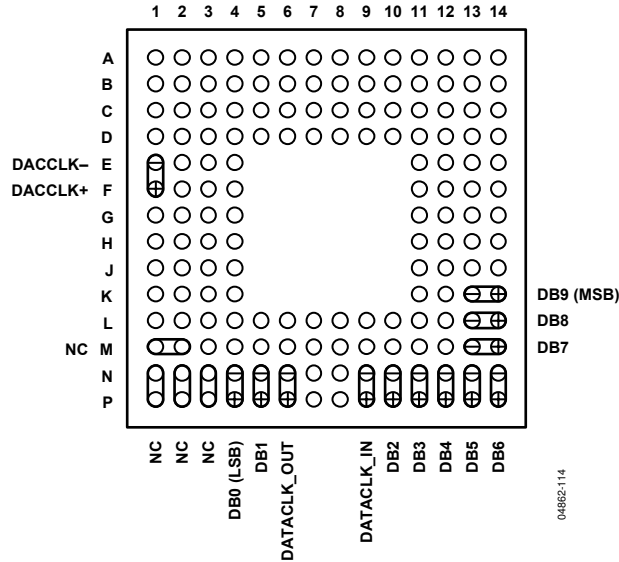


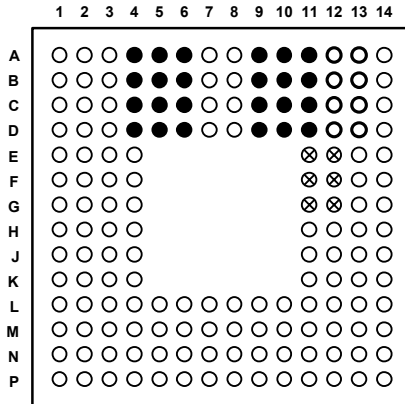
Figure 4. AD9734 Digital LVDS Input, Clock I/O (Top View)

Table 8. AD9734 Pin Function Descriptions

Pin No.	Mnemonic	Description
A1, A2, A3, B1, B2, B3, C1, C2, C3, D2, D3	CVDD18	1.8 V Clock Supply.
A4, A5, A6, A9, A10, A11, B4, B5, B6, B9, B10, B11, C4, C5, C6, C9, C10, C11, D4, D5, D6, D9, D10, D11	AVSS	Analog Supply Ground.
A7, B7, C7, D7	IOUTB	DAC Negative Output. 10 mA to 30 mA full-scale output current.
A8, B8, C8, D8	IOUTA	DAC Positive Output. 10 mA to 30 mA full-scale output current.
A12, A13, B12, B13, C12, C13, D12, D13	AVDD33	3.3 V Analog Supply.
A14	DNC	Do Not Connect.
B14	I120	Nominal 1.2 V Reference. Tie to analog ground via 10 kΩ resistor to generate a 120 μA reference current.
C14	VREF	Band Gap Voltage Reference I/O. Tie to analog ground via 1 nF capacitor; output impedance approximately 5 kΩ.
D1, E2, E3, E4, F2, F3, F4, G1, G2, G3, G4	CVSS	Clock Supply Ground.
D14	IPTAT	Factory Test Pin. Output current, proportional to absolute temperature, is approximately 10 μA at 25°C with a slope of approximately 20 nA/°C.
E1, F1	DACCLK-/DACCLK+	Negative/Positive DAC Clock Input (DACCLK).
E11, E12, F11, F12, G11, G12	AVSS	Analog Supply Ground Shield. Tie to AVSS at the DAC.
E13	IRQ/UNSIGNED	If PIN_MODE = 0, IRQ: Active low open-drain interrupt request output, pull up to DVDD33 with 10 kΩ resistor. If PIN_MODE = 1, UNSIGNED: Digital input pin where 0 = twos complement input data format, 1 = unsigned.
E14	RESET/PD	If PIN_MODE = 0, RESET: 1 resets the AD9734. If PIN_MODE = 1, PD: 1 puts the AD9734 in the power-down state.
F13	CSB/2x	See the Serial Peripheral Interface section and the Pin Mode Operation section for pin description.
F14	SDIO/FIFO	See the Pin Mode Operation section for pin description.
G13	SCLK/FSC0	See the Pin Mode Operation section for pin description.
G14	SDO/FSC1	See the Pin Mode Operation section for pin description.
H1, H2, H3, H4, H11, H12, H13, H14, J1, J2, J3, J4, J11, J12, J13, J14	DVDD18	1.8 V Digital Supply.
K1, K2, K3, K4, K11, K12, L2, L3, L4, L5, L6, L9, L10, L11, L12, M3, M4, M5, M6, M9, M10, M11, M12	DVSS	Digital Supply Ground.

Pin No.	Mnemonic	Description
K13, K14	DB<9>-/DB<9>+	Negative/Positive Data Input Bit 9 (MSB). Conforms to IEEE-1596 reduced range link.
L1	PIN_MODE	0 = SPI Mode. SPI is enabled. 1 = PIN Mode. SPI is disabled; direct pin control.
L7, L8, M7, M8, N7, N8, P7, P8	DVDD33	3.3 V Digital Supply.
L13, L14	DB<8>-/DB<8>+	Negative/Positive Data Input Bit 8. Conforms to IEEE-1596 reduced range link.
M1, M2	NC	No Connect.
M13, M14	DB<7>-/DB<7>+	Negative/Positive Data Input Bit 7. Conforms to IEEE-1596 reduced range link.
N1, P1	NC	No Connect.
N2, P2	NC	No Connect.
N3, P3	NC	No Connect.
N4, P4	DB<0>-/DB<0>+	Negative/Positive Data Input Bit 0 (LSB). Conforms to IEEE-1596 reduced range link.
N5, P5	DB<1>-/DB<1>+	Negative/Positive Data Input Bit 1. Conforms to IEEE-1596 reduced range link.
N6, P6	DATACLK_OUT-/ DATACLK_OUT+	Negative/Positive Data Output Clock. Conforms to IEEE-1596 reduced range link.
N9, P9	DATACLK_IN-/ DATACLK_IN+	Negative/Positive Data Input Clock. Conforms to IEEE-1596 reduced range link.
N10, P10	DB<2>-/DB<2>+	Negative/Positive Data Input Bit 2. Conforms to IEEE-1596 reduced range link.
N11, P11	DB<3>-/DB<3>+	Negative/Positive Data Input Bit 3. Conforms to IEEE-1596 reduced range link.
N12, P12	DB<4>-/DB<4>+	Negative/Positive Data Input Bit 4. Conforms to IEEE-1596 reduced range link.
N13, P13	DB<5>-/DB<5>+	Negative/Positive Data Input Bit 5. Conforms to IEEE-1596 reduced range link.
N14, P14	DB<6>-/DB<6>+	Negative/Positive Data Input Bit 6. Conforms to IEEE-1596 reduced range link.

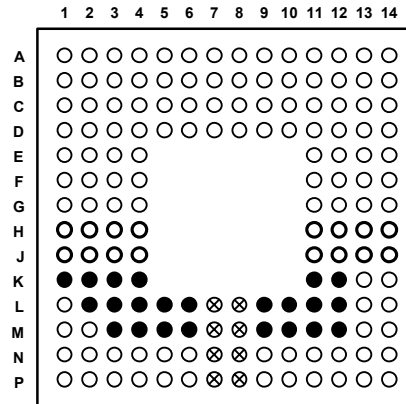
LOCATION OF SUPPLY AND CONTROL PINS



- AVDD33, 3.3V, ANALOG SUPPLY
- AVSS, ANALOG SUPPLY GROUND
- ⊗ AVSS, ANALOG SUPPLY GROUND SHIELD

Figure 5. Analog Supply Pins (Top View)

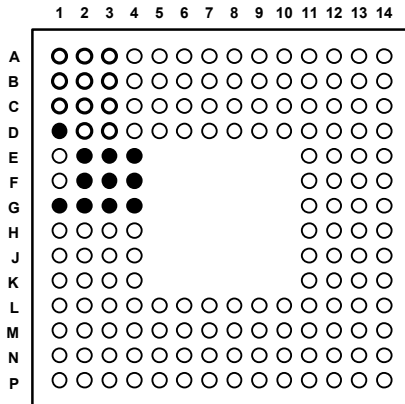
04882-002



- DVDD18, 1.8V DIGITAL SUPPLY
- ⊗ DVDD33, 3.3V DIGITAL SUPPLY
- DVSS DIGITAL SUPPLY GROUND

Figure 7. Digital Supply Pins (Top View)

04882-004



- CVDD18, 1.8V CLOCK SUPPLY
- CVSS, CLOCK SUPPLY GROUND

Figure 6. Clock Supply Pins (Top View)

04882-003

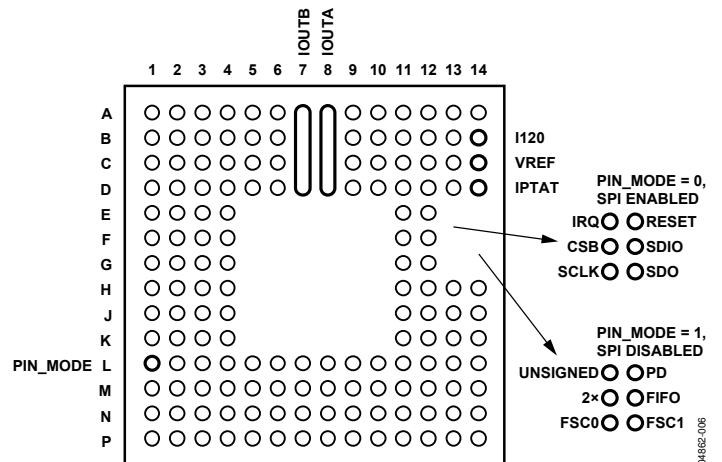


Figure 8. Analog I/O and SPI Control Pins (Top View)

04882-006

TERMINOLOGY

Linearity Error (Integral Nonlinearity or INL)

The maximum deviation of the actual analog output from the ideal output, determined by a straight line drawn from zero to full scale.

Differential Nonlinearity (DNL)

The measure of the variation in analog value, normalized to full scale, associated with a 1 LSB change in digital input code.

Monotonicity

A DAC is monotonic if the output either increases or remains constant as the digital input increases.

Offset Error

The deviation of the output current from the ideal of zero. For IOUTA, 0 mA output is expected when the inputs are all 0s. For IOUTB, 0 mA output is expected when all inputs are set to 1s.

Gain Error

The difference between the actual and ideal output span. The actual span is determined by the output when all inputs are set to 1s minus the output when all inputs are set to 0s.

Output Compliance Range

The range of allowable voltage at the output of a current output DAC. Operation beyond the maximum compliance limits can cause either output stage saturation or breakdown, resulting in nonlinear performance.

Temperature Drift

Specified as the maximum change from the ambient (25°C) value to the value at either T_{MIN} or T_{MAX} . For offset and gain drift, the drift is reported in ppm of full-scale range (FSR) per °C. For reference drift, the drift is reported in ppm per °C.

Power Supply Rejection

The maximum change in the full-scale output as the supplies are varied from nominal to minimum and maximum specified voltages.

Settling Time

The time required for the output to reach and remain within a specified error band about its final value, measured from the start of the output transition.

Glitch Impulse

Asymmetrical switching times in a DAC give rise to undesired output transients that are quantified by a glitch impulse. It is specified as the net area of the glitch in pV-s.

Spurious-Free Dynamic Range

The difference, in dB, between the rms amplitude of the output signal and the peak spurious signal over the specified bandwidth.

Total Harmonic Distortion (THD)

The ratio of the rms sum of the first six harmonic components to the rms value of the measured input signal. It is expressed as a percentage or in decibels (dB).

Multitone Power Ratio

The spurious-free dynamic range containing multiple carrier tones of equal amplitude. It is measured as the difference between the rms amplitude of a carrier tone to the peak spurious signal in the region of a removed tone.

TYPICAL PERFORMANCE CHARACTERISTICS

AD9736 STATIC LINEARITY, 10 mA FULL SCALE

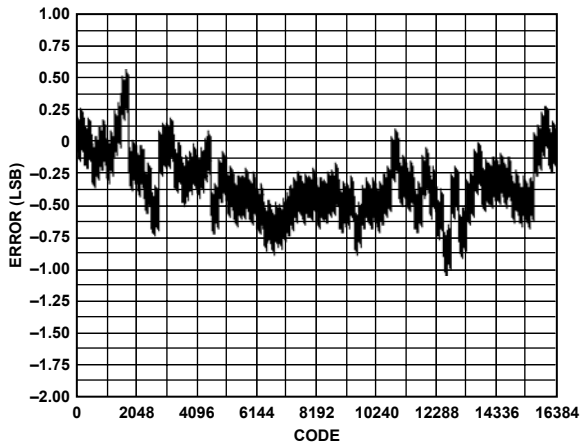


Figure 9. AD9736 INL, -40°C, 10 mA FS

04862-008

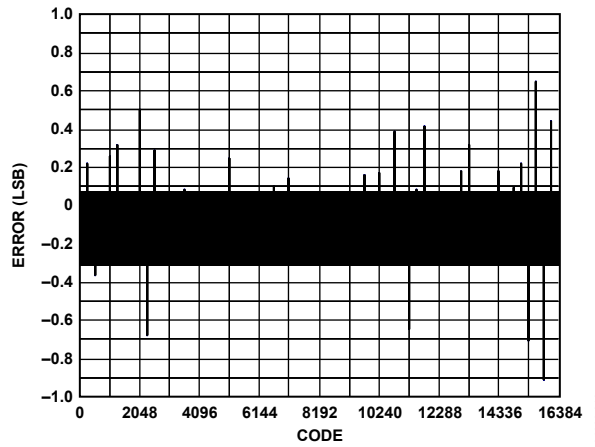


Figure 12. AD9736 DNL, -40°C, 10 mA FS

04862-010

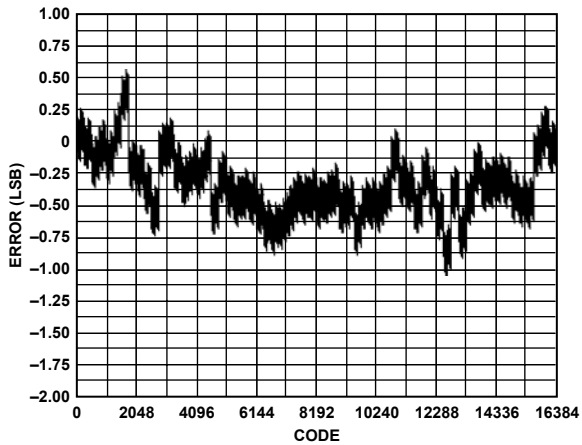


Figure 10. AD9736 INL, 25°C, 10 mA FS

04862-008

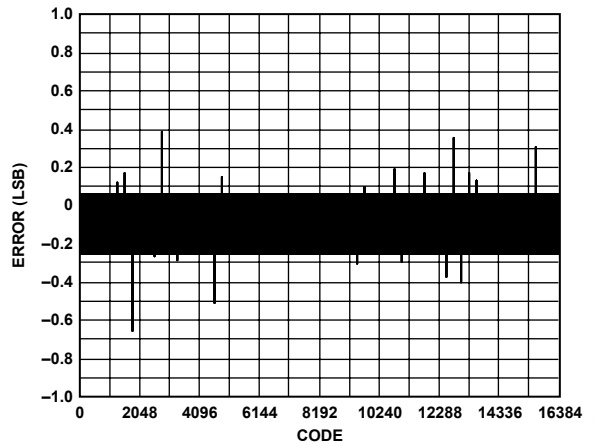


Figure 13. AD9736 DNL, 25°C, 10 mA FS

04862-011

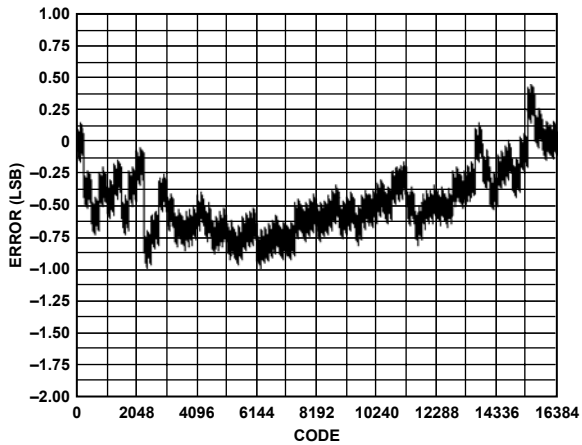


Figure 11. AD9736 INL, 85°C, 10 mA FS

04862-009

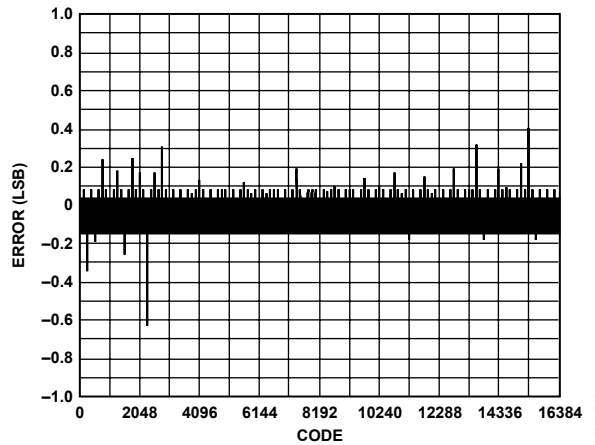


Figure 14. AD9736 DNL, 85°C, 10 mA FS

04862-012

AD9736 STATIC LINEARITY, 20 mA FULL SCALE

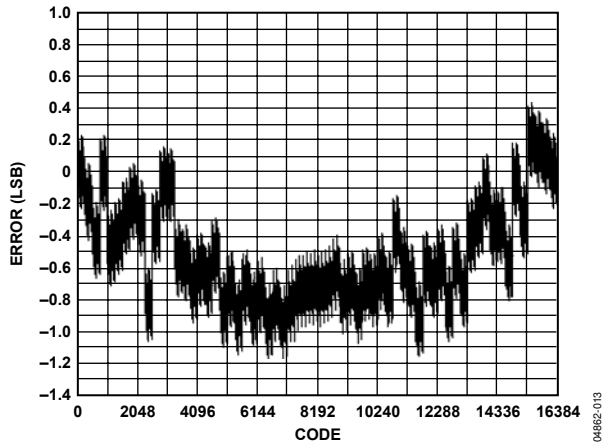


Figure 15. AD9736 INL, -40°C, 20 mA FS

04862-013

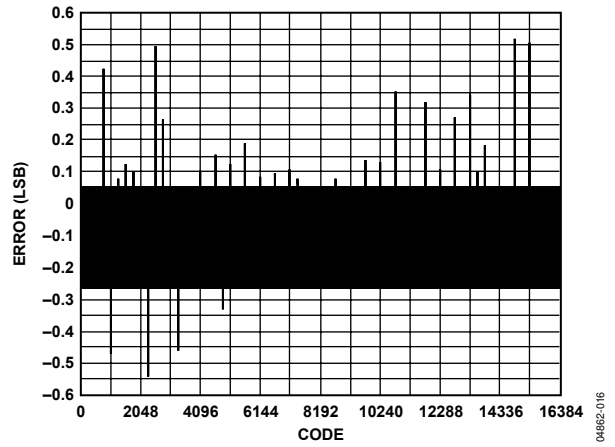


Figure 18. AD9736 DNL, -40°C, 20 mA FS

04862-016

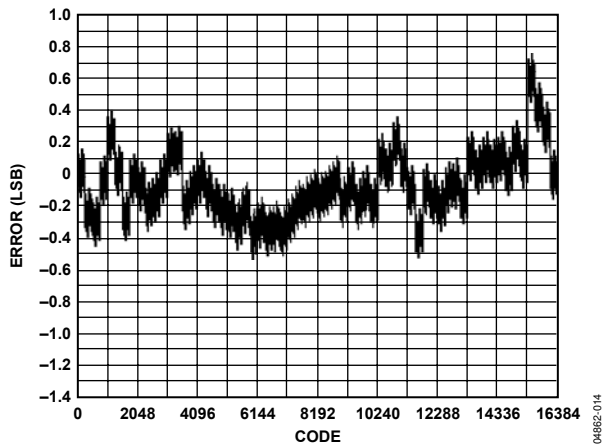


Figure 16. AD9736 INL, 25°C, 20 mA FS

04862-014

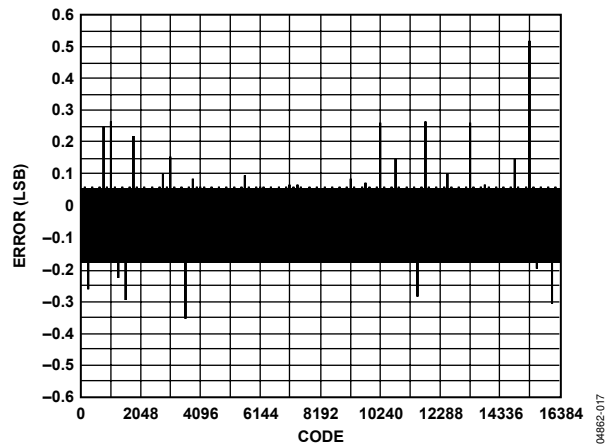


Figure 19. AD9736 DNL, 25°C, 20 mA FS

04862-017

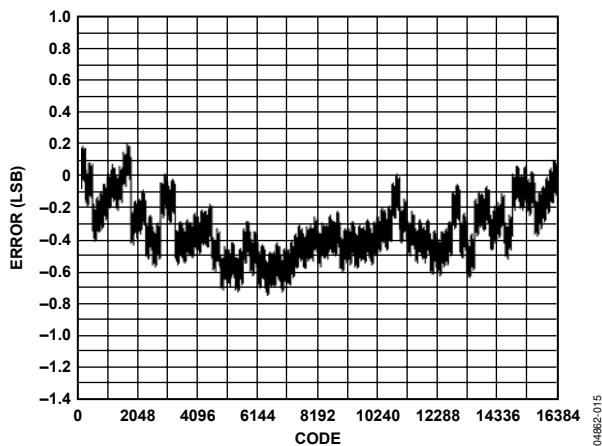


Figure 17. AD9736 INL, 85°C, 20 mA FS

04862-015

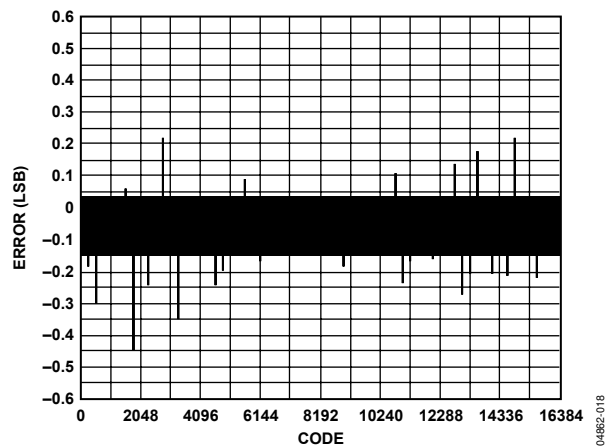


Figure 20. AD9736 DNL, 85°C, 20 mA FS

04862-018

AD9734/AD9735/AD9736

AD9736 STATIC LINEARITY, 30 mA FULL SCALE

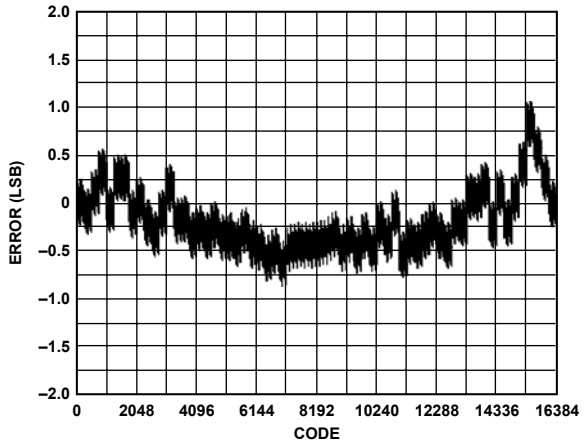


Figure 21. AD9736 INL, -40°C, 30 mA FS

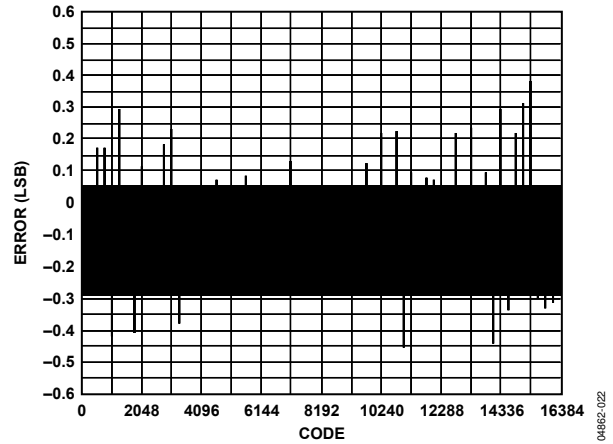


Figure 24. AD9736 DNL, -40°C, 30 mA FS

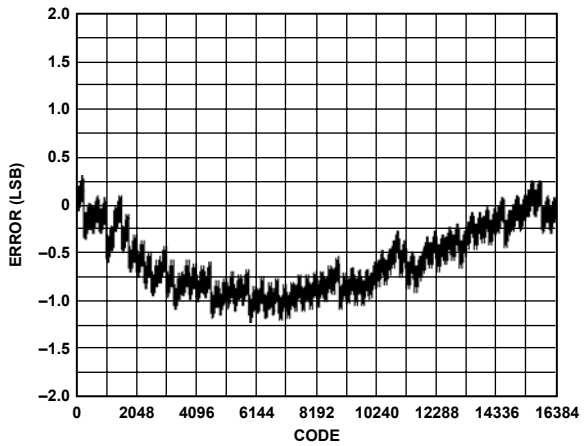


Figure 22. AD9736 INL, 25°C, 30 mA FS

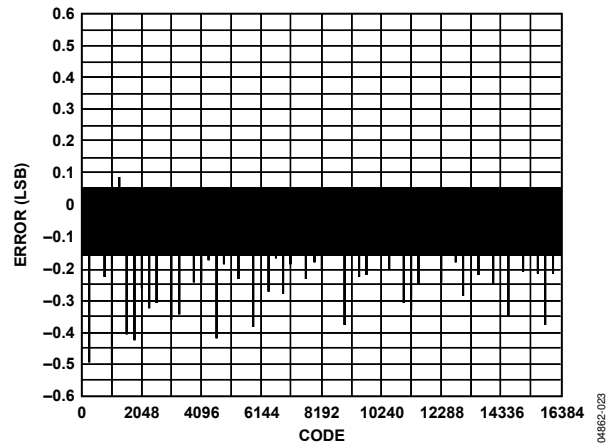


Figure 25. AD9736 DNL, 25°C, 30 mA FS

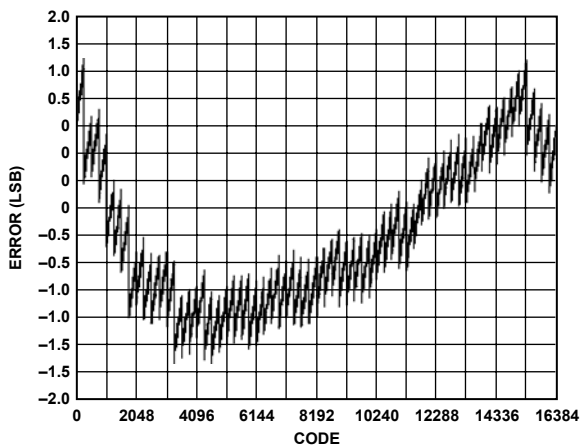


Figure 23. AD9736 INL, 85°C, 30 mA FS

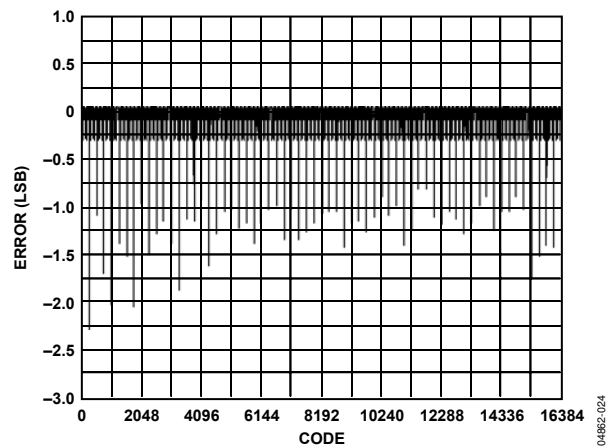


Figure 26. AD9736 DNL, 85°C, 30 mA FS

AD9735 STATIC LINEARITY, 10 mA, 20 mA, 30 mA FULL SCALE

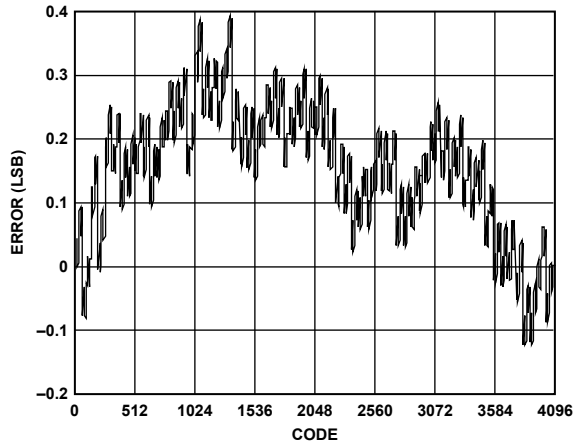


Figure 27. AD9735 INL, 25°C, 10 mA FS

04982-025

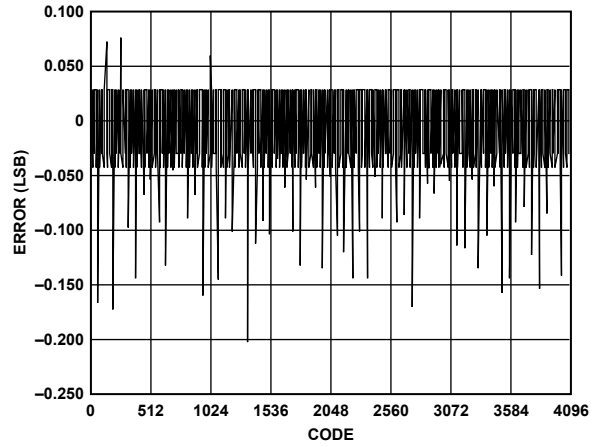


Figure 30. AD9735 DNL, 25°C, 10 mA FS

04982-028

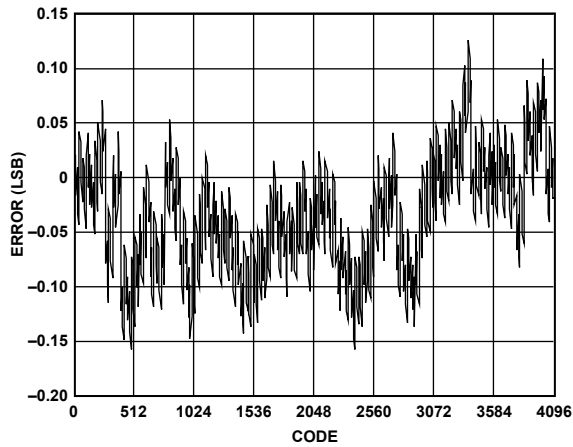


Figure 28. AD9735 INL, 25°C, 20 mA FS

04982-026

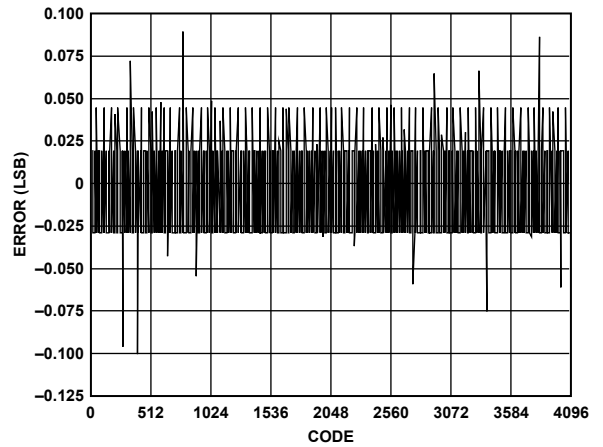


Figure 31. AD9735 DNL, 25°C, 20 mA FS

04982-029

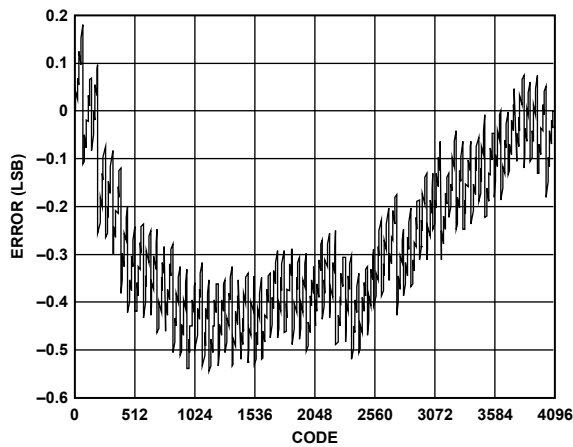


Figure 29. AD9735 INL, 25°C, 30 mA FS

04982-027

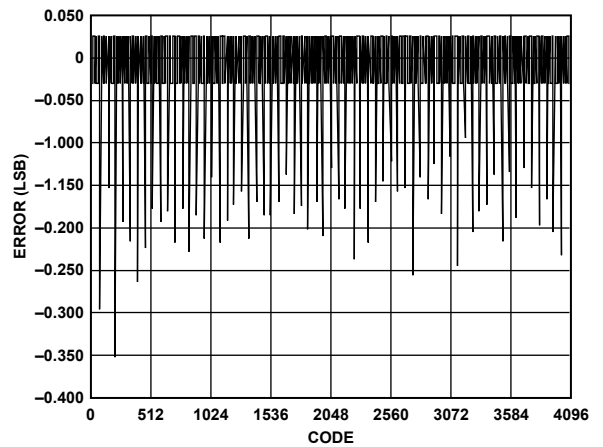


Figure 32. AD9735 DNL, 25°C, 30 mA FS

04982-030

AD9734/AD9735/AD9736

AD9734 STATIC LINEARITY, 10 mA, 20 mA, 30 mA FULL SCALE

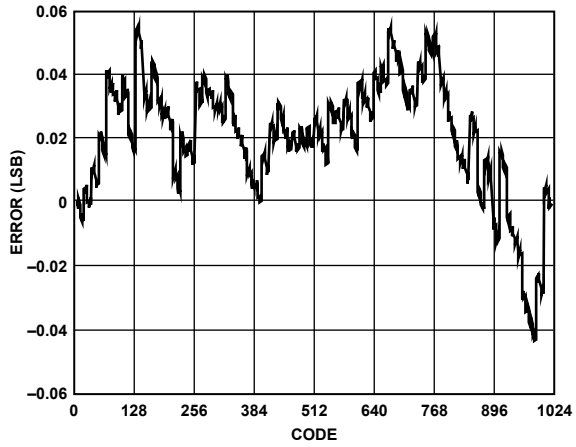


Figure 33. AD9734 INL, 25°C, 10 mA FS

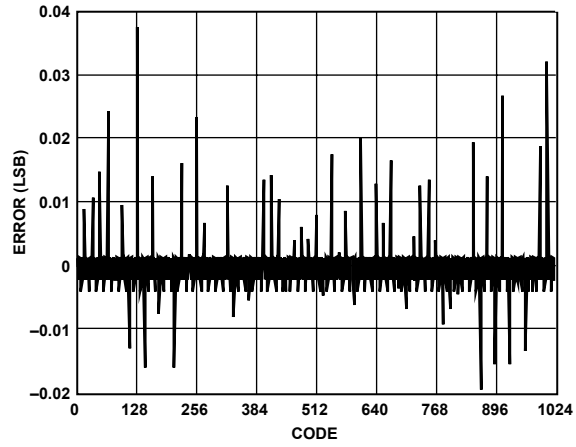


Figure 36. AD9734 DNL, 25°C, 10 mA FS

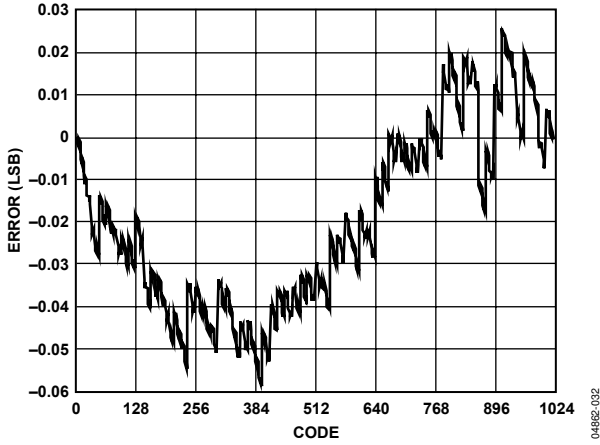


Figure 34. AD9734 INL, 25°C, 20 mA FS

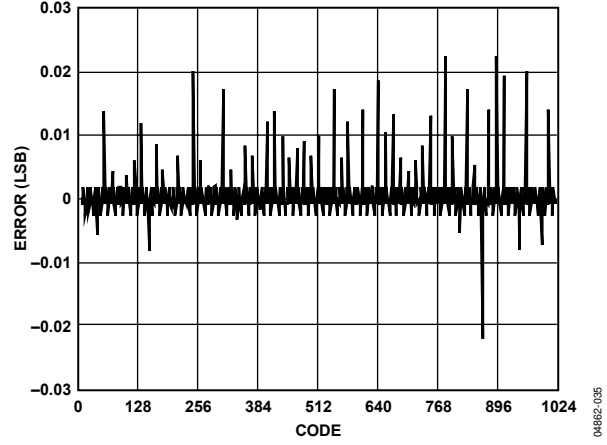


Figure 37. AD9734 DNL, 25°C, 20 mA FS

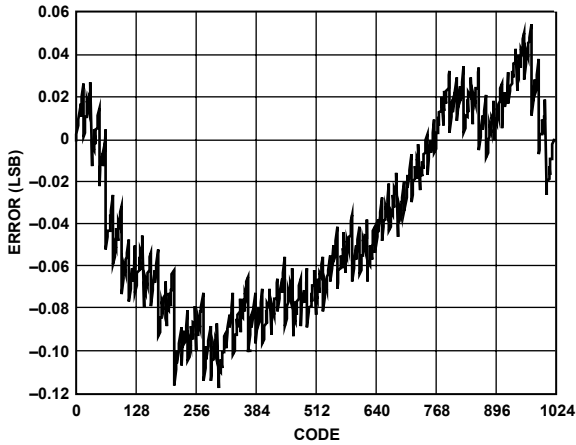


Figure 35. AD9734 INL, 25°C, 30 mA FS

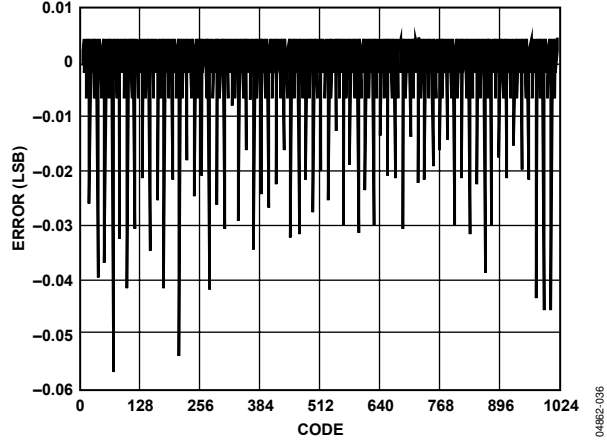


Figure 38. AD9734 DNL, 25°C, 30 mA FS

AD9736 POWER CONSUMPTION, 20 mA FULL SCALE

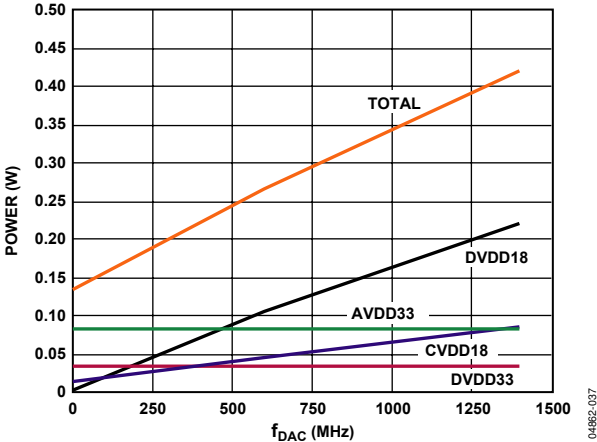


Figure 39. AD9736 1x Mode Power vs. f_{DAC} at 25°C

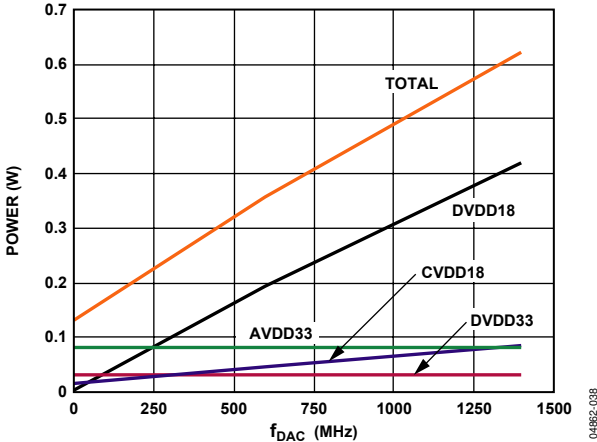


Figure 40. AD9736, 2x Interpolation Mode Power vs. f_{DAC} at 25°C

AD9734/AD9735/AD9736

AD9736 DYNAMIC PERFORMANCE, 20 mA FULL SCALE

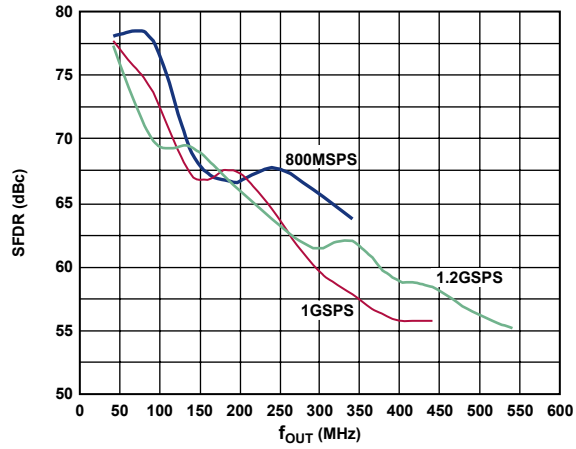


Figure 41. AD9736 SFDR vs. f_{OUT} over f_{DAC} at 25°C

04882-039

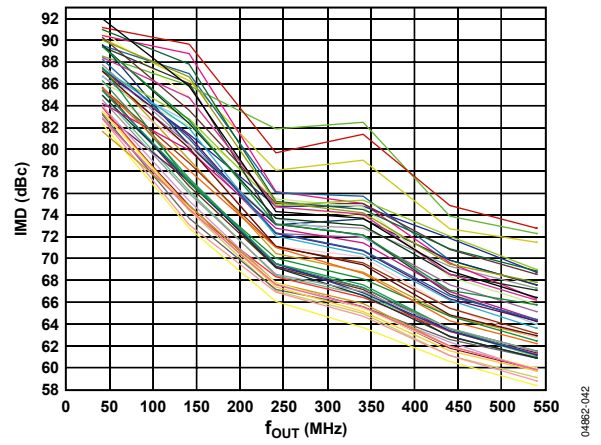


Figure 44. AD9736 IMD vs. f_{OUT} over 50 Parts, 25°C, 1.2 GSPS

04882-042

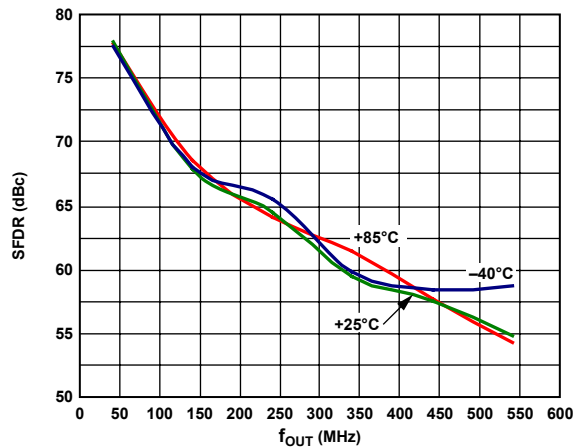


Figure 42. AD9736 SFDR vs. f_{OUT} over Temperature

04882-040

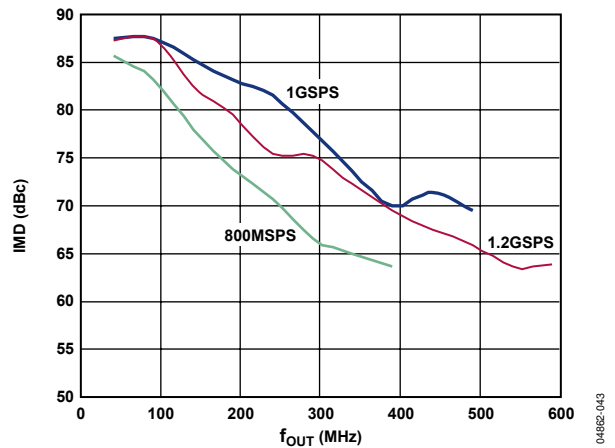


Figure 45. AD9736 IMD vs. f_{OUT} over f_{DAC} at 25°C

04882-043

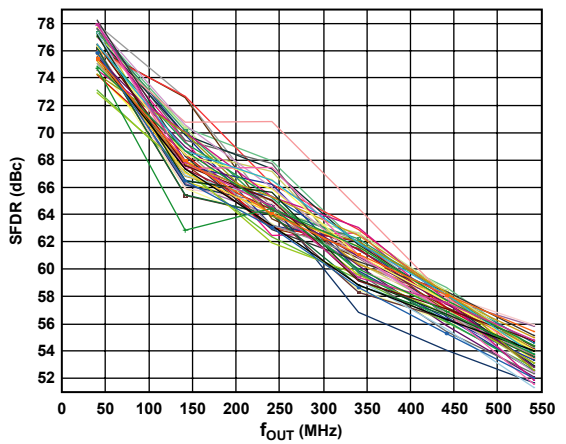


Figure 43. AD9736 SFDR vs. f_{OUT} over 50 Parts, 25°C, 1.2 GSPS

04882-041

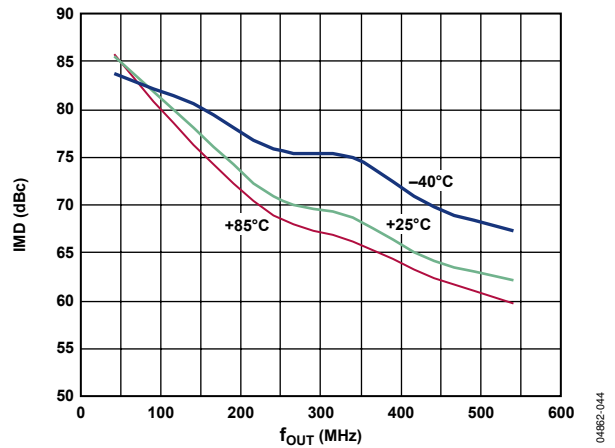


Figure 46. AD9736 IMD vs. f_{OUT} over Temperature, 1.2 GSPS

04882-044

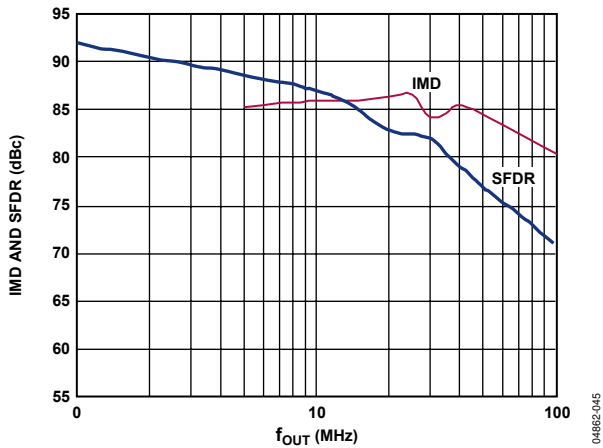


Figure 47. AD9736 Low Frequency IMD and SFDR vs. f_{OUT} , 25°C, 1.2 GSPS

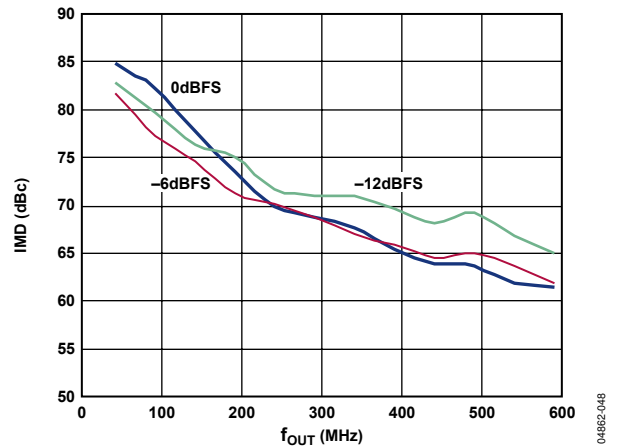


Figure 50. AD9736 IMD vs. f_{OUT} over A_{OUT} , 25°C, 1.2 GSPS

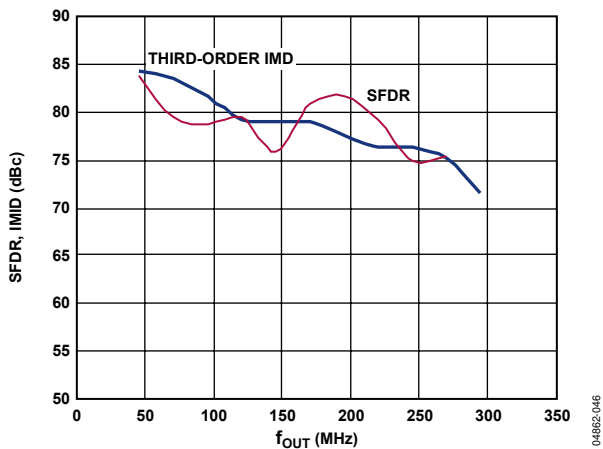


Figure 48. AD9736 IMD and SFDR vs. f_{OUT} , 25°C, 1.2 GSPS, 2x Interpolation

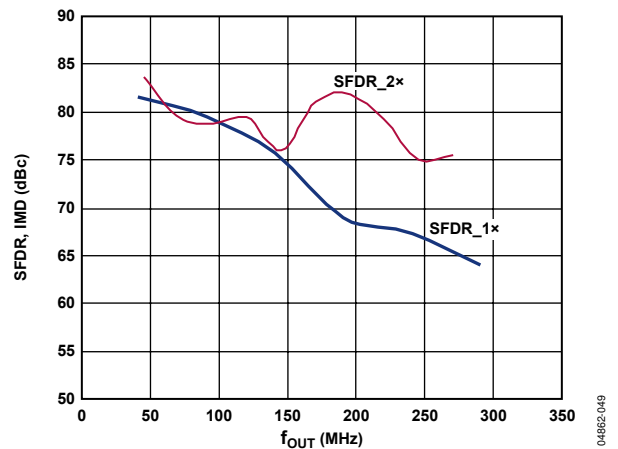


Figure 51. AD9736 SFDR vs. f_{OUT} , 25°C, 1.2 GSPS, 1x and 2x Interpolation

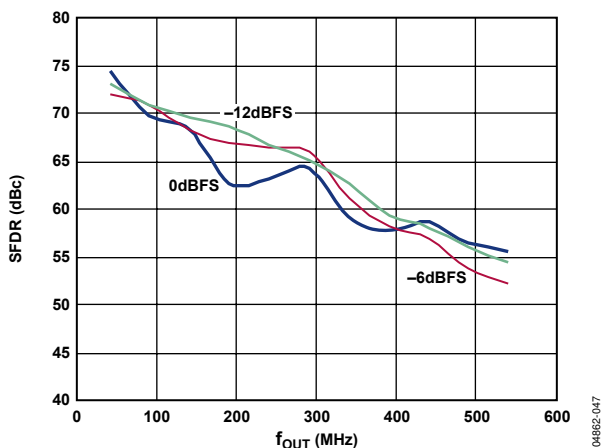


Figure 49. AD9736 SFDR vs. f_{OUT} over A_{OUT} , 25°C, 1.2 GSPS

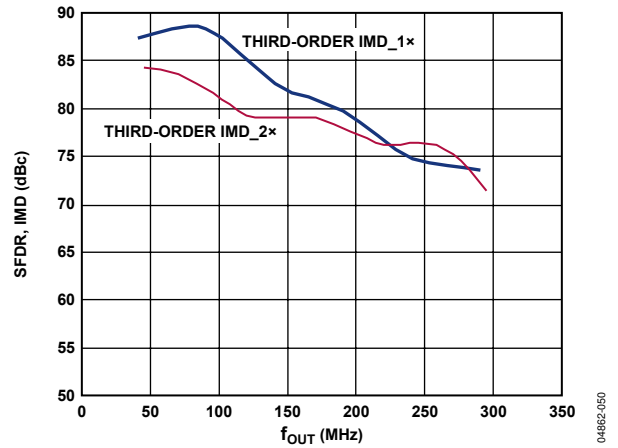


Figure 52. AD9736 IMD vs. f_{OUT} , 25°C, 1.2 GSPS, 1x and 2x Interpolation